

SUD50P04-09L

Vishay Siliconix

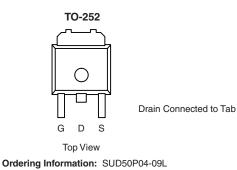
P-Channel 40-V (D-S), 175 °C MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A) ^d	
- 40	0.0094 at V _{GS} = - 10 V	- 50	
	0.0145 at V _{GS} = - 4.5 V	- 50	

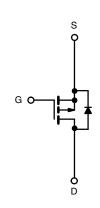
FEATURES

- TrenchFET[®] Power MOSFETS
- 175 °C Junction Temperature





SUD50P04-09L (Lead (Pb)-free)



P-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 40	v	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	1-	- 50 ^d		
	T _C = 125 °C	I _D	- 50 ^d	A	
Pulsed Drain Current		I _{DM}	- 100		
Avalanche Current		I _{AS}	- 50		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	125	mJ	
Power Dissinction	T _C = 25 °C	P _D	136 ^c	w	
Power Dissipation	T _A = 25 °C	۲D –	3 ^{b, c}	V	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
hunding to Ambient	$t \le 10 \text{ sec}$	R _{thJA}	15	18	°C/W
Junction-to-Ambient ^D	Steady State		40	50	
Junction-to-Case		R _{thJC}	0.82	1.1	

Notes:

a. Duty cycle \leq 1 %.

b. When Mounted on 1" square PCB (FR-4 material).

c. See SOA curve for voltage derating.

d. Package limited.

* Pb containing terminations are not RoHS compliant, exemptions may apply.

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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static	-,			71:			
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 40	1		v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 3		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = -32 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
	I _{DSS}	V_{DS} = - 32 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μA	
		$V_{DS} = -32 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			- 150		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 50			Α	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = - 10 V, I _D = - 24 A		0.0075	0.0094	Ω	
		V_{GS} = - 10 V, I _D = - 50 A, T _J = 125 °C			0.014		
		V_{GS} = - 10 V, I _D = - 50 A, T _J = 175 °C			0.017		
		V _{GS} = - 4.5 V, I _D = - 18 A		0.0115	0.0145		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 5 V, I _D = - 24 A		73		S	
Dynamic ^b	•	•		÷	ı		
Input Capacitance	C _{iss}			4800		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = -25 V$, f = 1 MHz		700			
Reverse Transfer Capacitance	C _{rss}			550			
Total Gate Charge ^c	Qg			102	150	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -20 V$, $V_{GS} = -10 V$, $I_{D} = -50 A$		18.5			
Gate-Drain Charge ^c	Q _{gd}			27			
Turn-On Delay Time ^c	t _{d(on)}			10	15	ns	
Rise Time ^c	t _r	$V_{DD} = -20 \text{ V}, \text{ R}_{L} = 0.4 \Omega$ $\text{I}_{D} \cong -50 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{G}} = 6 \Omega$		60	90		
Turn-Off Delay Time ^c	t _{d(off)}			145	220		
Fall Time ^c	t _f			140	220		
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b		·			
Continuous Current	۱ _S				- 50	А	
Pulsed Current	I _{SM}				- 100	~	
Forward Voltage ^a	V _{SD}	I _F = - 50 A, V _{GS} = 0 V		- 1.0	- 1.5	V	
Reverse Recovery Time	t _{rr}	I _F = - 50 A, di/dt = 100 A/μs		55	85	ns	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

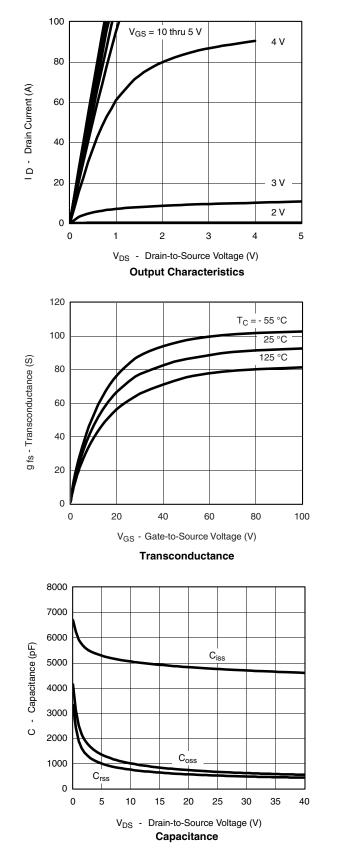
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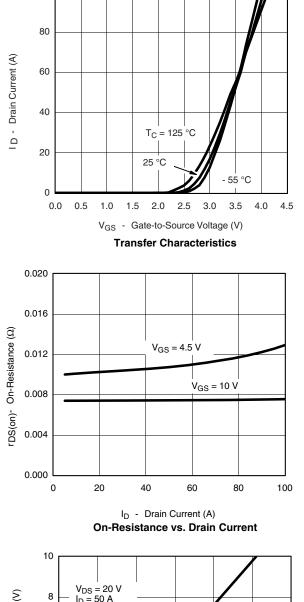


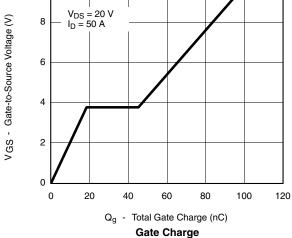
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100

 $T_J = 150 \degree C$

T_J = 25 °Ċ

1.2

1.5

Source Current (A)

' S 10

1

0.0

0.3

0.6

0.9

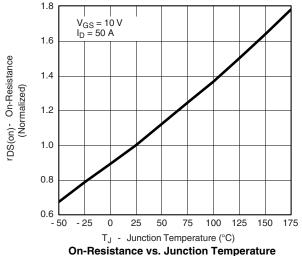
V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

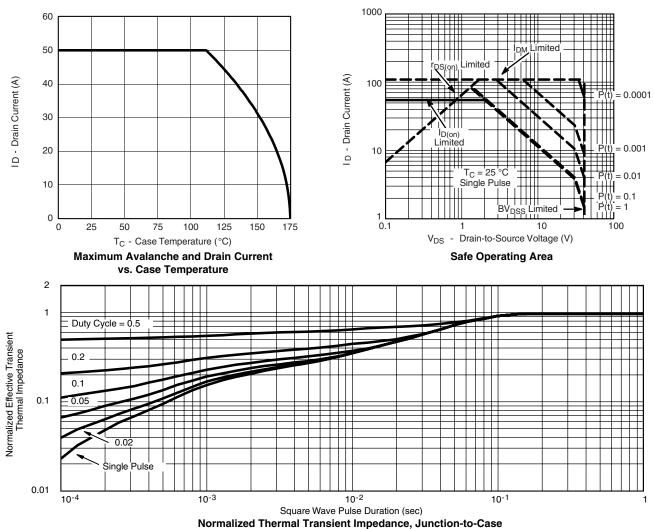
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TYPICAL CHARACTERISTICS 25 °C unless noted







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